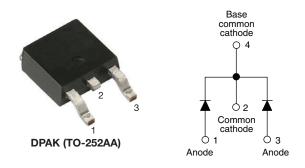
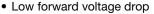


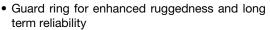
High Performance Schottky Rectifier, 2 x 6 A



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 x 6 A			
V _R	60 V			
V _F at I _F	0.57 V			
I _{RM}	35 mA at 125 °C			
T _J max.	150 °C			
E _{AS}	7 mJ			
Package	DPAK (TO-252AA)			
Circuit configuration	Common cathode			

FEATURES







- Popular DPAK outline
- · Center tap configuration
- · Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The VS-12CWQ06FN-M3 surface mount, center tap, Schottky rectifier series has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I _{F(AV)}	Rectangular waveform	12	A			
V _{RRM}		60	V			
I _{FSM}	t _p = 5 μs sine	320	Α			
V _F	6 A _{pk} , T _J = 125 °C (per leg)	0.57	V			
T _J	Range	-55 to +150	°C			

VOLTAGE RATINGS						
PARAMETER SYMBOL VS-12CWQ06FN-M3 UNITS						
Maximum DC reverse voltage	V_{R}	60 V				
Maximum working peak reverse voltage	V_{RWM}	00	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	per leg	_	50 % duty cycle at T _C = 131 °C, rectangular waveform		6	А
See fig. 5	per device	I _{F(AV)}			12	
Maximum peak one cycle non-repetitive surge current See fig. 7		I _{FSM}	5 μs sine or 3 μs rect. pulse	Following any rated	320	А
			10 ms sine or 6 ms rect. pulse	rated V _{RRM} applied	105	
Non-repetitive avalanche energy per leg E _{AS}		E _{AS}	T _J = 25 °C, I _{AS} = 1.2 A, L = 10 mH		7	mJ
Repetitive avalanche current per leg		I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T_J maximum $V_A = 1.5 \times V_R$ typical		0.8	Α



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CO	VALUES	UNITS		
		6 A	T _{.1} = 25 °C	0.61	V	
Maximum forward voltage drop per leg	V _{FM} ⁽¹⁾	12 A	11=23 0	0.79		
See fig. 1	VFM (1)	6 A	T _{.1} = 125 °C	0.57		
3		12 A	1J = 125 C	0.72		
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C		3	- mA	
See fig. 2	'RM ` ′	T _J = 125 °C	V _R = Rated V _R	35	IIIA	
Threshold voltage	V _{F(TO)}			0.36	V	
Forward slope resistance	r _t	$T_J = T_J$ maximum		24.14	mΩ	
Typical junction capacitance per leg	C _T	$V_R = 5 V_{DC}$, (test signal ran	360	pF		
Typical series inductance per leg	L _S	Measured lead to lead 5 m	nm from package body	5.0	nH	

Note

 $^{^{(1)}\,}$ Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J ⁽¹⁾ , T _{Stg}		-55 to +150	°C	
Maximum thermal resistance,	per leg	В	DC operation	3.0	°C/W	
junction to case	per device	R_{thJC}	See fig. 4	1.5	C/VV	
Annyayimata wajaht				0.3	g	
Approximate weight				0.01	OZ.	
Marking device			Case style DPAK (TO-252AA)	12CW	Q06FN	

Note

 $^{^{(1)} \ \}frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}} \ thermal \ runaway \ condition \ for a \ diode \ on \ its \ own \ heatsink$



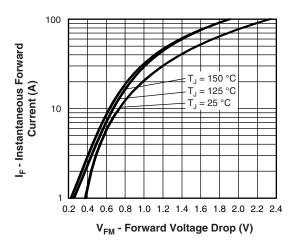


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

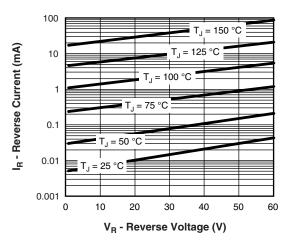


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

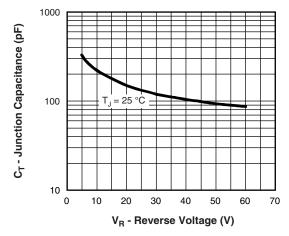


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

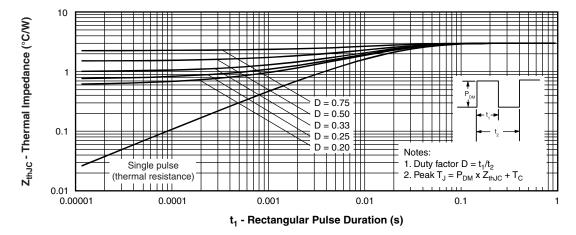


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)



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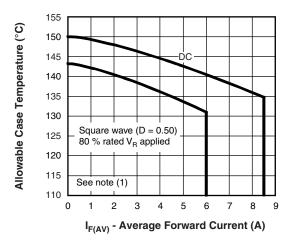


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

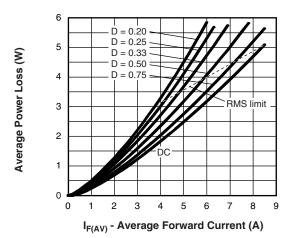


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

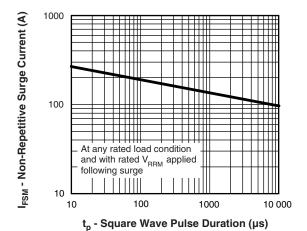


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

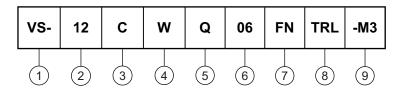
Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_{R1} = 80 \text{ \% rated } V_R \\ \end{array}$



ORDERING INFORMATION TABLE





1 - Vishay Semiconductors product

Current rating (12 A)

Center tap configuration

4 - Package identifier:

W = DPAK

5 - Schottky "Q" series

6 - Voltage rating (06 = 60 V)

7 - FN = TO-252AA

8 - • None = tube

• TR = tape and reel

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

9 - Environmental digit:

-M3 = halogen-free, RoHS-compliant and terminations lead (Pb)-free

ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-12CWQ06FN-M3	75	3000	Antistatic plastic tube			
VS-12CWQ06FNTR-M3	2000	2000	13" diameter reel			
VS-12CWQ06FNTRL-M3	3000	3000	13" diameter reel			
VS-12CWQ06FNTRR-M3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95627			
Part marking information	www.vishay.com/doc?95176			
Packaging information	www.vishay.com/doc?95033			
SPICE model	www.vishay.com/doc?95278			



D-PAK (TO-252AA) "M"

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	
е	2.29	BSC	0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108 REF.		
L2	0.51	BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0° 10°		0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA



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